

MEMORANDUM OF UNDERSTANDING (MoU)

Between

The Department of Electrical and Electronics Engineering

Dayananda Sagar Academy of Technology and Management (DSATM),

(Dayananda Sagar Institutions (DSI) -2nd Campus),

Bengaluru-560082

AND



JUST ROBOTICS / SPENROIT TECHNOLOGIES PVT. LTD.

#16, IKP EDEN, 3rd Floor,

Bhuvanappa Layout,

Tavarekere Main Road, Bengaluru-560029



PREAMBLE

This Memorandum of Understanding (MoU) is entered by and between the

The Department of Electrical and Electronics Engineering of the Dayananda Sagar Academy of Technology and Management (DSATM), (Dayananda Sagar Institutions (DSI) – 2nd Campus), Udayapura, Kanakapura Road, Opp. Art of Living, Bangalore–560082 and Just Robotics, #16, IKP EDEN, 3rd Floor, Bhuvanappa Layout, Tavarekere Main Road, Bengaluru–560029. The EEE-Dept, DSATM and Just Robotics / Spenroit Technologies are now herein, referred to collectively, as "Parties" or, individually as "Party."

1. PURPOSE

The Parties recognize the benefits to be derived from increased collaboration, cooperation and interaction for the further promotion and understanding of robotics, mechatronics, Internet of Things etc. and other related hardware technological frontiers. The purpose of this MoU is to define the areas for fundamental, academic& industrial research in which the Parties desire to work together in the future for their mutual benefit to foster a collaborative framework between EEE-Dept, DSATM and Just Robotics / Spenroit Technologies in the said fields with a view of benefiting from each other's initiatives and working procedures.

2. SCOPE

This MoU sets forth the intentions of the Parties for increased collaboration, cooperation and interaction and does not create any legally binding commitments. If the Parties later

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Dayananda Rogal & Stank of Technology & Management
Udayapura, Kanakapura Road

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4.2 Treatment of intellectual property rights developed through collaborations under this MoU will be determined between the Parties through mutual consultation and separate written agreements on a case-by-case basis.

5. CONFIDENTIALITY

The parties agree that there is no intention to share any confidential or, proprietary information in any collaboration under this MoU. If either Party wishes to disclose information it considers to be confidential or proprietary to the other Party, the Parties will enter into a written non-disclosure agreement. It is also understood and agreed that no information will be exchanged or, disseminated under any collaborations pursuant to this MoU which is export controlled pursuant to the export control laws of government, including The Export Administration Regulations and the International Traffic in Arms Regulations for INDIA or, any Foreign Exchange and Foreign Trade Act.

6. DURATION

This MoU shall be effective for a period of three (3) years from the date of final signature. It may be modified or, extended by mutual written agreement by the Parties. This MoU may be terminated by either party upon six (6) months advance written notice.

The Parties to this Memorandum of Understanding (MoU) hereby confirm their agreement to its terms by the following signatures:

Dr. R. Bhaduri

Head of the Department

Department of Electrical & Electronics Engg.

DSI-2nd Campus (DSATM),

Bengaluru - 560082.

Date: 9th Feb'2018

Dr. R. Bhaduri (Ph.D.(N.I.T.), MIE(I), MIEEE(USA)
Head of the Department & Associate Professor
Department of Electrical & Electronics Engineering,
Dayananda Sagar Institutions, 2nd Campus (DSATM)
Bangalore - 560 082.

Dr P 9 Lakshmikantha Ph D Pr ncipal / Director

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By Lat.

Mr. Brijesh C A

CEO

Just Robotics / Spenroit Technologies Pvt. Ltd. #16, IKP EDEN, 3rd Floor, Bhuvanappa Layout, Tavarekere Main Road, Bengaluru-560029



Or P. 9 Lakshmikantha Ph.D. Vanakat Ashrama
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